

HPE Renew Remanufacturing Process

Quality remanufactured products backed by Hewlett Packard Enterprise

For more information

To learn more about HPE Renew, visit hpe.com/us/hpe-renew



Hewlett Packard Enterprise (HPE) sets very stringent quality standards across the entire technology portfolio to meet the high expectations of our discerning customers. With HPE Renew products, you have our commitment of the same uncompromising high quality and performance that is expected from new HPE products.

The HPE Renew Promise

The HPE Renew portfolio includes Enterprise Servers, Enterprise and Commercial Storage, ProLiant Servers and Options, and Networking products. The vast majority of HPE Renew products are from our HPE Demo pool, and are also sourced from factory excess and customer returns. All HPE Renew products are certified to have passed our rigorous HPE Renew remanufacturing and quality inspection processes, ensuring they are fully restored to meet HPE certified standards. The rigorous building and testing processes verify that all HPE Renew products meet equivalent to new standards. It is only then that they qualify for original same-as-new factory warranty—your mark of HPE quality and reliability. In addition, service and support options are equivalent to that offered with new products and the most current operating system and software revisions are installed.

The checklist below details step by step how the HPE Renew remanufacturing process truly ensures that all products are a true reflection of new HPE products.

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HPE Renew Technical Remanufacturing Checklist

INCOMING PRODUCT INSPECTION

1. Products must pass a cosmetic inspection based on strict HPE Factory Standards.	If the parts do not meet the following requirements they are replaced with original HPE
new parts:	

- On visible front-facing surfaces (Class 1), light scratches must measure less than 6cm, deep scratches must measure less than 2mm
- Any areas of blemishes, abrasions or water spots must measure less than 1.5cm
- Any dents on panels
- Any rusts spots
- 2. System Power up and configuration checks performed
- 3. Validation of parts against Bill of Materials
- 4. Component inspections, such as memory and hard disks, must bear manufacturer's seals of authenticity, otherwise they are rejected and scrapped for recycling
- 5. All cables and accessories are scrapped for recycling and replaced by new ones
- 6. Perform Engineering Change Notification checks to latest new product factory specifications

RECONDITIONING

- $\textbf{7.} \ \mathsf{Once} \ \mathsf{required} \ \mathsf{components} \ \mathsf{are} \ \mathsf{removed}, \ \mathsf{accessible} \ \mathsf{areas} \ \mathsf{in} \ \mathsf{the} \ \mathsf{chassis} \ \mathsf{are} \ \mathsf{cleaned}$
- $\boldsymbol{8.}$ Intensive cleaning of all sub-assembly parts and racks
- **9.** Removal of labels and regeneration of new product labels
- 10. Minor touch up of external surfaces may occur if needed

ASSEMBLY & SOFTWARE INSTALLATIONS

- 11. Product component assembly and system integration
- 12. Storage drives reformatted and retested to ensure data integrity, every drive is wiped clean of any data and every disk is separately overwritten
- 13. Restore Factory Default settings and reset all password settings
- $\textbf{14.} \ \text{Restore licensed version of Operating System Software and install latest Firmware updates}$

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PRODUCT FUNCTIONAL TEST

Fa CM PC Te	onfiguration and System Settings INS IOS IBus/Serial Port/USB Devices Imperature Status Pripheral Interconnect Tests	Product configuration checks Hardware checks via system LED/LCD displays Unit Serial number update System and I/O firmware verification and updates Fan status checks	Random data pattern tests Detect and read tests Temperature caution tests
CM PC Te	OI Bus/Serial Port/USB Devices	• Fan status checks	Detect and read tests Temperature caution tests
PC Te Pe	CI Bus/Serial Port/USB Devices		Detect and read tests Temperature caution tests
Te Pe	mperature Status		Temperature caution tests
Pe			
_	ripheral Interconnect Tests		
Pre			 All Hot-plug Hard disk slots interconnectivity test DVD/CD-ROM boot and O/S installation checks LAN connectivity
	ocessor	• CPU clock speed	Real-time clock test cycles Up to 24hr run-in tests
Me	emory	Memory size and slot test	Random address testsRead/write testMarch/noise/walk/ECC testsUp to 24hr run-in tests
Ha	Hard disk	• RAID setup and configuration	Read/write Tests Sequential and random read tests Short and extended offline Tests SCSI SMART status checks Glist tests < 100 Complete disk wiping (meets HPE privacy standards)
SCSI Adapt	tors, Fibre Channel Host Bus adapters, SAN s	switches, LAN etc, are tested where options apply	
Mandatory	electrical safety Hipot/Ground bond tests		
AL PRODU	UCT INSPECTION AND DELIVERABLES		
Archive tes	st logs and product manifest outputs for test	status verifications	
Include nev	west versions of product documentations and	d/or CD kits	

21. Re-packaging in new HPE boxes or wood crates as per HPE factory standard packaging procedures

 $\textbf{22.} \ \mathsf{The} \ \mathsf{warranty} \ \mathsf{period} \ \mathsf{is} \ \mathsf{reset} \ \mathsf{in} \ \mathsf{the} \ \mathsf{HPE} \ \mathsf{Worldwide} \ \mathsf{Service} \ \mathsf{Database} \ \mathsf{upon} \ \mathsf{shipment} \ \mathsf{date}$

23. Product is ready for delivery and installation

Data sheet

